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Rohm Semiconductor RSS090N03FU6TB

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RSS090N03

Transistors

Switching (30V, 9A)

RSS090N03

Features

- 1) Low on-resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small and Surface Mount Package (SOP8).

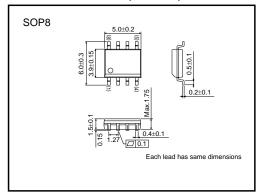
Application

Power switching, DC/DC converter.

●Structure

Silicon N-channel MOS FET

●External dimensions (Unit : mm)

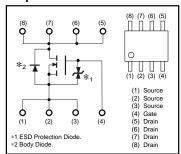


● Absolute maximum ratings (Ta = 25°C)

Parameter		Symbol	Limits	Unit	
Drain-Source Voltage		Voss	30	V	
Gate-Source Voltage		Vgss	20	V	
Drain Current	Continuous	ΙD	±9.0	Α	
	Pulsed	IDP	±36	A *1	
Source Current (Body Diode)	Continuous	ls	1.6	А	
	Pulsed	Isp	6.4	A *1	
Total Power Dissipation		Po	2	W *2	
Channel Temperature		Tch	150	°C	
Storage Temperature		Tstg	-55 to +150	°C	

^{*1} Pw≤10μs, Duty cycle≤1%

●Equivalent circuit



^{*} A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use a protection circuit when the fixed

●Thermal resistance (Ta = 25°C)

Parameter	Symbol	Limits	Unit
Channel to Ambient	Rth (ch-a)	62.5	°C/W *

^{*} Mounted on a ceramic board.

^{*2} Mounted on a ceramic board.



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●Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Gate-Source Leakage	lgss	-	-	10	μΑ	Vgs=20V, Vps=0V
Drain-Source Breakdown Voltage	V (BR)DSS	30	-	_	V	ID=1mA, VGS=0V
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	VDS=30V, VGS=0V
Gate Threshold Voltage	VGS (th)	1.0	_	2.5	V	Vos=10V, Io=1mA
Static Drain-Source On-State Resistance	RDS (on)*	_	11	15	mΩ	In=9A, Vgs=10V
		_	15	22		In=9A, Vgs=4.5V
		_	17	24		In=9A, Vgs=4V
Forward Transfer Admittance	I Y₅ I*	6.0	_	_	S	ID=9A, VDS=10V
Input Capacitance	Ciss	_	810	_	pF	Vps=10V
Output Capacitance	Coss	_	225	_	pF	V _G s=0V
Reverse Transfer Capacitance	Crss	_	160	_	pF	f=1MHz
Turn-On Delay Time	td(on) *	_	10	_	ns	ID=4.5A, VDD≒ 15V
Rise Time	tr *	_	13	_	ns	V _G s=10V
Turn-Off Delay Time	td(off) *	_	46	_	ns	RL=3.33Ω
Fall Time	t _f *	_	15	_	ns	R _G s=10Ω
Total Gate Charge	Qg *	-	11	15	nC	V _{DD} =15V
Gate-Source Charge	Qgs *	_	2.5	_	nC	V _G s=5V
Gate-Drain Charge	Q _{gd} *	_	4.5	_	nC	ID=9A

^{*}Pulsed

●Body diode characteristics (Source-Drain Characteristics) (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Forward Voltage	Vsp *	-	_	1.2	V	Is=6.4A, Vgs=0V

^{*}Pulsed

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Electrical characteristic curves

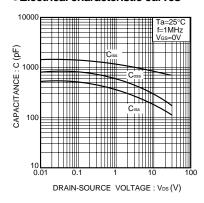


Fig.1 Typical Capacitance vs. Drain-Source Voltage

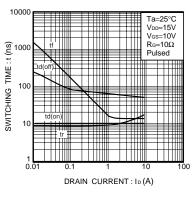


Fig.2 Switching Characteristics

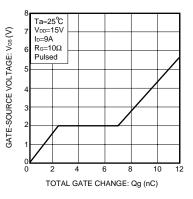


Fig.3 Dynamic Input Characteristics

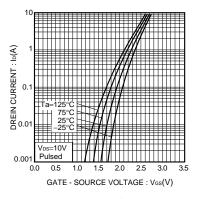


Fig.4 Typical Transfer Characteristics

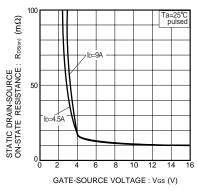


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

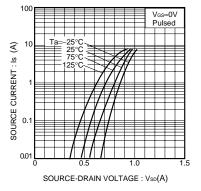


Fig.6 Source-Current vs. Source-Drain Voltage

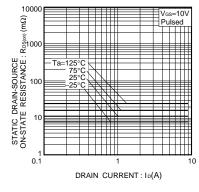


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (1)

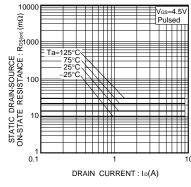


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (2)

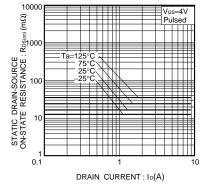


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (3)

Distributor of Rohm Semiconductor: Excellent Integrated System Limited

Datasheet of RSS090N03FU6TB - MOSFET N-CH 30V 9A 8-SOIC

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Appendix

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